$I_{FAV} = 2x \cdot 10 A$ 

150 V

0.74 V



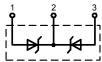
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# **Schottky**

High Performance Schottky Diode Low Loss and Soft Recovery Common Cathode

Part number (Marking on product)

**DSA 20 C 150PN** 



### Features / Advantages:

- Very low Vf
- Extremely low switching losses
- Low Irm-values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- · Low noise switching
- Low losses



# **Applications:**

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters



### Package:

 $V_{RRM} =$ 

TO-220FPAB

- Industry standard outline
- Plastic overmolded tab for electrical isolation
- Epoxy meets UL 94V-0
- RoHŚ compliant

#### Ratings

Symbol	Definition	Conditions		min.	typ.	max.	Unit
V <sub>RRM</sub>	max. repetitive reverse voltage		T <sub>VJ</sub> = 25 °C			150	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 150 V	T <sub>VJ</sub> = 25 °C			0.3	mA
		$V_{R} = 150 \text{ V}$	$T_{VJ}$ = 125 °C			3	mA
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 10 A	T <sub>VJ</sub> = 25°C			0.88	V
		$I_F = 20 A$				0.99	V
		I <sub>F</sub> = 10 A	T <sub>VJ</sub> = 125 °C			0.74	V
		$I_F = 20 A$				0.86	V
I <sub>FAV</sub>	average forward current	rectangular, d = 0.5	T <sub>C</sub> = 140 °C			10	Α
V <sub>F0</sub>	threshold voltage slope resistance for power loss calculation only		T <sub>v.i</sub> = 175 °C			0.55	V
	slope resistance \( \) 10r power loss	calculation only				11.5	$m\Omega$
R <sub>thJC</sub>	thermal resistance junction to case					4.50	K/W
T <sub>vJ</sub>	virtual junction temperature			-55		175	°C
P <sub>tot</sub>	total power dissipation		T <sub>c</sub> = 25 °C			35	W
I <sub>FSM</sub>	max. forward surge current	$t_p = 10  \text{ms}  (50  \text{Hz}),  \text{sine}$	T <sub>VJ</sub> = 45 °C			60	Α
CJ	junction capacitance	V <sub>R</sub> = V; f = 1 MHz	T <sub>VJ</sub> = 25 °C				pF
E <sub>AS</sub>	non-repetitive avalanche energy	I <sub>AS</sub> = A; L = 100 μH	T <sub>VJ</sub> = 25 °C			tbd	mJ
I <sub>AR</sub>	repetitive avalanche current	$V_A = 1.5 \cdot V_R \text{ typ.}; f = 10 \text{ kHz}$				tbd	Α



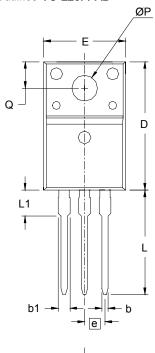
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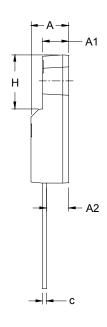
# Ratings

Symbol	Definition	Conditions	min.	typ.	max.	Unit
I <sub>RMS</sub>	RMS current	per pin*			35	Α
R <sub>thCH</sub>	thermal resistance case to heatsink			0.50		K/W
M <sub>D</sub>	mounting torque		0.4		0.6	Nm
F <sub>c</sub>	mounting force with clip		20		60	N
T <sub>stg</sub>	storage temperature		-55		150	°C
Weight				2		g

<sup>\*</sup> Irms is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip. In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

# Outlines TO-220FPAB





SYM	INCHES		MILLIMETERS		
2114	MIN	MAX	MIN	MAX	
Α	.177	.193	4.50	4.90	
A1	.092	.108	2.34	2.74	
A2	.101	.117	2.56	2.96	
b	.028	.035	0.70	0.90	
b1	.050	.058	1.27	1.47	
С	.018	.024	0.45	0.60	
D	.617	.633	15.67	16.07	
E	.392	.408	9.96	10.36	
е	.100 BSC		2.54 BSC		
Н	.255	.271	6.48	6.88	
L	.499	.523	12.68	13.28	
L1	.119	.135	3.03	3.43	
ØΡ	.121	.129	3.08	3.28	
Q	.126	.134	3.20	3.40	